

# Discription

The HESDNC5VB1AF-B protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD. It gives designer the flexibility to protect one bi-directional

line in applications where arrays are not practical.



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# Features

- ★ Low Leakage
- ★ Response Time is Typically < 1 ns
- ★ ESD Rating of Class 3 per Human Body Model
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ These are Pb-Free Devices
- ★ We declare that the material of product compliance with RoHS requirements and Halogen Free.

# **Ordering information**



**Circuit Diagram** 

Product ID	Pack	Qty(PCS)
HESDNC5VB1AF-B	DFN1006-2L	10000

# Absolute Ratings (Tamb=25°C)

Symbol	Parameter	Value	Units	
P <sub>PP</sub>	Peak Pulse Power (t <sub>P</sub> = 8/20µs)		66	W
TL	Maximum lead temperature for soldering during 10s		260	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range		-40 to +125	°C
Tj	Maximum junction temperature		150	°C
	IEC61000-4-2 (ESD) air disch contact disch	•	土25 土20	KV



# ELECTRICAL CHARACTERISTICS

	V <sub>RWM</sub> (V)	I <sub>R1</sub> (μΑ) @ V <sub>RWM</sub>	I <sub>R2</sub> (μΑ) @ V <sub>R</sub> =3.5V	V <sub>BR</sub> (V) (Note		ΙŢ	V <sub>C</sub> (V) @ lpp = 1 A (Note 3)	V <sub>C</sub> (V) @MAX I <sub>PP</sub> (Note 3)	<b>I<sub>PP</sub>(A)</b> (Note 3)	<b>P<sub>PK</sub>(W)</b> (Note 3)	C (pF)
Device	Max	Max	Max	Min	Max	mA	Max	Max	Max	Max	Тур
HESDNC5VB1AF-B	5.0	0.5	0.3	5.6	8.0	1.0	8.5	12	5.5	66	10

Other voltage available upon request.

- 2.  $V_{BR}$  is measured with a pulse test current IT at an ambient temperature of 25  $^\circ\!\!\mathrm{C}$
- 3. Surge current waveform per Figure 3.

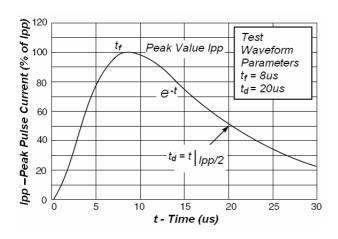
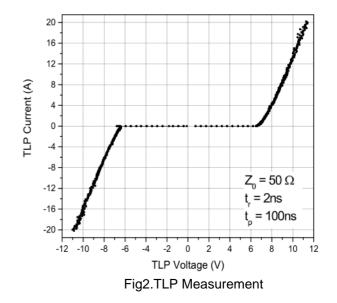
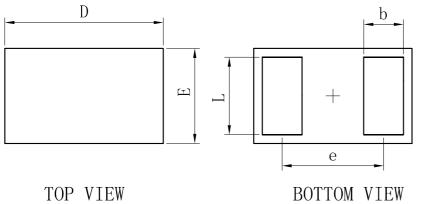


Fig1. Pulse Waveform



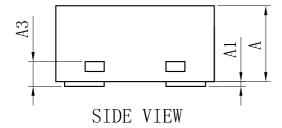


#### **OUTLINE AND DIMENSIONS**

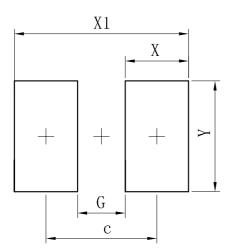


BOI	T(	DM	V

DFN1006-2L					
Dim	Min	Тур	Max		
D	0.95	1.00	1.05		
Е	0.55	0.60	0.65		
е	-	0.64	-		
L	0.44	0.49	0.54		
b	0.20	0.25	0.30		
А	0.43	0.48	0.53		
A1	0 – 0.05				
A3	0. 127REF.				
All Dimensions in mm					



#### SOLDERING FOOTPRINT



Dimensions	(mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Y	0.70



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